

Overview

KEMET's X7R dielectric features a 125°C maximum operating temperature and is considered temperature stable. The Electronics Components, Assemblies and Materials Association (EIA) characterizes X7R dielectric as a Class II material. Components of this classification are fixed, ceramic dielectric capacitors suited for bypass and decoupling applications or for frequency discriminating circuits where Q and stability of capacitance characteristics are not critical. X7R exhibits a predictable change in capacitance with respect to time and voltage, boasting a minimal change in capacitance with reference to ambient temperature. Capacitance change is limited to $\pm 15\%$ from -55° C to $\pm 125^{\circ}$ C.

Benefits

- -55°C to +125°C operating temperature range
- · Lead (Pb)-free, RoHS, and REACH Compliant
- Temperature stable dielectric
- EIA 0402, 0603, 0805, 1206, 1210, 1808, 1812, 1825, 2220, and 2225 case sizes
- DC voltage ratings of 6.3 V, 10 V, 16 V, 25 V, 35 V, 50 V, 100 V, 200 V, and 250 V
- Capacitance offerings ranging from 10 pF to 47 μ F
- Available capacitance tolerances of ±5%, ±10%, and ±20%
- · Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability
- SnPb termination finish option available upon request (5% Pb minimum)

Applications

Typical applications include decoupling, bypass, filtering and transient voltage suppression.





Ordering Information

С	1206	C	106	М	4	R	Α	С	TU
Ceramic	Case Size (L" x W")	Specification/ Series ¹	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination Finish ²	Packaging/ Grade (C-Spec)
	0402 0603 0805 1206 1210 1805 1808 1812 1825 2220 2225	C = Standard	Two significant digits and number of zeros.	J = ±5% K = ±10% M = ±20%	9 = 6.3 8 = 10 4 = 16 3 = 25 6 = 35 5 = 50 1 = 100 2 = 200 A = 250	R = X7R	A = N/A	C = 100% Matte Sn	See "Packaging C-Spec Ordering Options Table"

¹ Flexible termination option is available. Please see FT-CAP product bulletin C1013_X7R_FT-CAP_SMD.

² Additional termination finish options may be available. Contact KEMET for details.

Packaging C-Spec Ordering Options Table

Packaging Type ¹	Packaging/Grade Ordering Code (C-Spec)
Bulk Bag/Unmarked	Not required (Blank)
7" Reel/Unmarked	TU
13" Reel/Unmarked	7411 (EIA 0603 and smaller case sizes) 7210 (EIA 0805 and larger case sizes)
7" Reel/Marked	ТМ
13" Reel/Marked	7040 (EIA 0603) 7215 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch ²	7081
13" Reel/Unmarked/2 mm pitch ²	7082

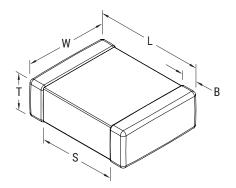
¹ Default packaging is "Bulk Bag." An ordering code C-Spec is not required for "Bulk Bag" packaging.

¹ The terms "Marked" and "Unmarked" pertain to laser marking option of capacitors. All packaging options labeled as "Unmarked" will contain capacitors that have not been laser marked. Please contact KEMET if you require a laser marked option. For more information see "Capacitor Marking."

² The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information."



Dimensions – Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0402	1005	1.00 (0.040) ±0.05 (0.002)	0.50 (0.020) ±0.05 (0.002)		0.30 (0.012) ±0.10 (0.004)	0.30 (0.012)	Solder reflow only
06031	1608	1.60 (0.063) ±0.15 (0.006)	0.80 (0.032) ±0.15 (0.006)		0.35 (0.014) ±0.15 (0.006)	0.70 (0.028)	
0805 ²	2012	2.00 (0.079) ±0.20 (0.008)	1.25 (0.049) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)	0.75 (0.030)	Solder wave or Solder reflow
1206 ³	3216	3.20 (0.126) ±0.20 (0.008)	1.60 (0.063) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)		
12104	3225	3.20 (0.126) ±0.20 (0.008)	2.50 (0.098) ±0.20 (0.008)		0.50 (0.02) ±0.25 (0.010)		
1805	4513	4.50 (0.177) ±0.50 (0.020)	1.27 (0.050) ±0.38 (0.015)	See Table 2 for Thickness	0.60 (0.024) ±0.35 (0.014)		
1808	4520	4.70 (0.185) ±0.50 (0.020)	2.00 (0.079) ±0.20 (0.008)		0.60 (0.024) ±0.35 (0.014)	N/A	
1812	4532	4.50 (0.177) ±0.30 (0.012)	3.20 (0.126) ±0.30 (0.012)		0.60 (0.024) ±0.35 (0.014)	N/A	Solder reflow only
1825	4564	4.50 (0.177) ±0.30 (0.012)	6.40 (0.252) ±0.40 (0.016)		0.60 (0.024) ±0.35 (0.014)		
2220	5650	5.70 (0.224) ±0.40 (0.016)	5.00 (0.197) ±0.40 (0.016)		0.60 (0.024) ±0.35 (0.014)		
2225	5664	5.60 (0.220) ±0.40 (0.016)	6.40 (0.248) ±0.40 (0.016)		0.60 (0.024) ±0.35 (0.014)		

¹ For capacitance capacitance value 0.22 μ F 50V add 0.10 (0.004) to length

² For capacitance values ≥ 2.2 μ F add 0.10 (0.004) to the length tolerance dimension.

³ For capacitance value 10 μF 16 V add 0.10 (0.004) to the length tolerance dimension and for Capacitance value 1.0uF add 0.10 (0.004) to Length tolerance dimension.

⁴ For capacitance value 2.2µF 100 V add 0.10 to the Length tolerance dimension, for capacitance values \geq 4.7 µF add 0.02 (0.001) to the width tolerance dimension and 0.10 (0.004) to the length tolerance dimension, except for capacitance value 10µF 25 V and 50 V add 0.10 (0.004) to the width tolerance dimension and 0.20 (0.008) to the length tolerance dimension.



Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Environmental Compliance

Lead (Pb)-free, RoHS, and REACH compliant without exemptions.



Table 1A – Capacitance Range/Selection Waterfall (0402 – 1206 Case Sizes)

			se Si Serie			C	:04	02	C				(:06	03	С						CO	80	5C							C1	20	6 C			
Сар	Сар	Vol	tage C	ode	9	8	4	3	5	1	9	8	4	3	5	1	2	Α	9	8	4	3	6	5	1	2	Α	9	8	4	3	6	5	1	2	Α
oup	Code	Rat	ed Vol (VDC)		6.3	9	16	25	50	100	6.3	9	16	25	50	100	200	250	6.3	9	16	25	35	50	100	200	250	6.3	9	16	25	35	50	100	200	250
		Cap	Tolera	ance					Pı	odu	ct A	vaila	abili	ty a	nd C	hip 1	Thic	knes	ss C	ode	s – S	See 1	able	e 2 f	or C	hip 1	Thic	knes	ss D	imeı	nsio	ns				
10 - 20 pF*	100 - 200*	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF		DN	DN	DN	DN	DN	DN	DN	DN		EB	EB	EB	EB	EB	EB	EB	EB	
22 pF	220	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF		DM	DM	DM	DM	DM	DM	DN	DN		EB	EB	EB	EB	EB	EB	EB	EB	
24-91pF	240 - 910*	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF		DN	DN	DN	DN	DN	DN	DN	DN		EB	EB	EB	EB	EB	EB	EB	EB	
100 - 150 pF**	101 - 151**	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF		DN	DN	DN	DN	DN	DN	DN	DN		EB	EB	EB	EB	EB	EB	EB	EB	
180 - 820 pF**	181 - 821**	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF		DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	
1000pF	102	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
1200 pF	122	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
1500 pF	152	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
1800 pF	182	J	K	м	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
2200 pF	222	J	K	м	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
2700 pF	272	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
3300 pF	332	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
3900 pF	392	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
4700 pF	472	J	K	М	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
5600 pF	562	J	K	М	BB	BB	BB	BB	BB	BB	CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
6800 pF	682	J	K	М	BB	BB	BB	BB	BB	BB	CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
8200 pF	822	J	к	м	BB	BB	BB	BB	BB	BB	CF	CF	CF	CF	CF	CF	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
10000 pF	103	J	к	м	BB	BB	BB	BB	BB	BB	CG	CG	CG	CG	CG	CG	CF	CF	DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
12000 pF	123	J	к	м	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF			DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
15000 pF	153	J	к	м	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF			DN	DN	DN	DN	DN	DN	DN	DN	DN	EQ	EQ	EQ	EQ	EQ	EQ	EQ	EQ	EQ
18000 pF	183	J	K	M	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF			DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB	EB	EB
22000 pF	223	J	K	M	BB	BB	BB	BB	BB		CF	CF	CF	CF	CF	CF			DN	DN	DN	DN	DN	DN	DN	DN	DN	EB	EB	EB	EB	EB	EB	EB		EB
27000 pF	273	J	K	М	BB	BB	BB	BB			CF	CF	CF	CF	CF	CF			DN	DN	DN	DN		DN	DP	DE		EB	EB	EB	EB	EB	EB	EB		EB
		Rat	ed Vol		m.	6	16	25	50	100	6.3	2	16	25	20	100	200	250	6.3	5	16	25	35	50	100	200	250	6.3	10	16	25	35	50	100	200	250
	Cap		(VDC)		ف						—																									
Cap	Code		tage C		9	8	4	3	5	1	9	8	4	3	5	1	2	A	9	8	4	3	6	5	1	2	A	9	8	4	3	6	5	1	2	A
			ise Si Serie				C04	02C						C06	030							C(0805	iC							C	1206	5C			

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91). **Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82). xx¹ Available only in K and M tolerance.

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Table 1A – Capacitance Range/Selection Waterfall (0402 – 1206 Case Sizes) cont.

			se Si Serie			(C04	02	C				(C06	03(C						CO)80	5C							C 1	20	6C			
Сар	Сар	Vol	tage C	ode	9	8	4	3	5	1	9	8	4	3	5	1	2	A	9	8	4	3	6	5	1	2	A	9	8	4	3	6	5	1	2	A
oup	Code	Rat	ed Vol (VDC)		6.3	5	16	25	50	100	6.3	5	16	25	50	100	200	250	6.3	5	16	25	35	50	100	200	250	6.3	9	16	25	35	50	100	200	250
		Cap	Toler	ance					P	rodu	ct A	vaila	abili	ity a	nd C	hip '	Thic	kne	ss C	ode	s – S	See T	Tabl	e 2 f	or C	hip [·]	Thic	kne	ss D	imeı	nsio	ns				
33000 pF	333	J	K	М	BB	BB	BB	BB			CF	CF	CF	CF	CF	CF			DN	DN	DN	DN	DN	DN	DP	DE	DG	EB	EB	EB	EB	EB	EB	EB	EB	EB
39000 pF	393	J	K	M	BB	BB	BB	BB			CF	CF	CF	CF	CF	CF			DN	DN	DN	DN	DN	DN	DP	DE	DG	EB	EB	EB	EB	EB	EB	EC	EB	EB
47000 pF	473	J	K	M	BB	BB	BB	BB			CG	CG	CG	CG	CJ	CF			DO	DO	DO	DO	DO	DO	DE	DG	DG	EB	EB	EB	EB	EB	EB	EC	ED	ED
56000 pF	563	J	K	M	BB	BB	BB				CF	CF	CF	CF	CF	CJ			DP	DP	DP	DP	DP	DP	DE	DG	DG	EB	EB	EB	EB	EB	EB	EB	ED	ED
68000 pF	683	J	K	M	BB	BB	BB				CF	CF	CF	CF	CF	CJ			DP	DP	DP	DP	DP	DP	DE	DG	DG	EB	EB	EB	EB	EB	EB	EB	ED	ED
82000 pF	823	J	K	M	BB	BB	BB				CF	CF	CF	CF	CF	CJ			DP	DP	DP	DP	DP	DP	DE			EB	EB	EB	EB	EB	EB	EB	ED	ED
0.1 µF	104	J	K	M	BB	BB	BB	BB1			CJ	CJ	CJ	CJ	CJ	CJ			DN	DN	DN	DN	DN	DN	DH			EB	EB	EB	EB	EB	EB	EB	EM	EM
0.12 µF	124	J	K	М							CF	CF	CF	CF	CF				DN	DN	DN	DN	DP	DP	DG			EC	EC	EC	EC	EC	EC	EC	EG	EM
0.15 µF	154	J	K	M							CF	CF	CF	CF	CF				DN	DN	DN	DN	DP	DP	DG			EC	EC	EC	EC	EC	EC	EC	EG	EG
0.18 µF	184	J	K	M							CF	CF	CF	CF					DN	DN	DN	DN	DG	DG	DG			EC	EC	EC	EC	EC	EC	EC	EM	EM
0.22 µF	224	J	K	M	BB ²	BB ²	BB ²	BB ²			CF	CF	CF	CF	CJ				DN	DN	DN	DN	DG	DG	DG			EC	EC	EC	EC	EC	EC	EC	EG	EG
0.27 µF	274	J	K	М							CF	CF	CF						DP	DP	DP	DP	DP	DP				EB	EB	EB	EB	EC	EC	EM		
0.33 µF	334	J	K	М							CF	CF	CF						DG	DG	DG	DG	DP	DP				EB	EB	EB	EB	EC	EC	EG		
0.39 µF	394	J	к	м	1						CF	CF	CF						DG	DG	DG	DG	DE	DE				EB	EB	EB	EB	EC	EC	EG		
0.47 µF	474	J	к	м	BB1	BB1					CF	CF	CF	CG					DG	DG	DG	DG	DE	DE				EC	EC	EC	EC	EC	EC	EG		
0.56 µF	564	J	K	M									-						DP	DP	DP	DG		DH				ED	ED	ED	ED	EC	EC	EM		
0.68 µF	684	J	K	M															DP	DP	DP	DG		DH				EF	EF	EF	EF	ED	ED	EM		
0.82 µF	824	Ĵ	K	M															DP	DP	DP	DG		5				EF	EF	EF	EF	ED	ED	EH		
1μF	105	Ĵ	ĸ	M							CG	CG	CG	C.I1					DH	DH			יווח	DH1				EP	EP	EP	EP	ED	ED	EH		
1.2 μF	125	Ĵ	K	M							00	00		00					DE		DE							ED	ED	ED	EG					
1.5 µF	155	Ĵ	K	M															DG		DG							ED	ED	ED	EG	EH				
1.8 µF	185	J	K	M															DG		DG							ED	ED	ED	EF	EH	EH			
2.2 µF	225	J	K	M							CG1	CG1							DH	-	_	DH1	рн1	DH1				EH	EH	EH1	EH1		EH			
2.7 µF	275	J	ĸ	M							00	00																EN	EN	EN	EH					
2.7 μF 3.3 μF	335	J	K	M																								ED	ED	ED	EH					
3.9 μF	395	J	K	M	1																							EF	EF	EF	EH					
4.7 μF	475	J	ĸ	M															пн	пн	DH	пн						EH	EH	EH		EH1	EH1			
4.7 μF 5.6 μF	565	J	K	M																								EH	EH	EH		EIT				
5.0 μF 6.8 μF	685	J	K	M																								EH		EH						
0.0 μF 8.2 μF	825	J	K	M																								EH	EH							
ο.2 μ Γ 10 μF	106	J	K	M															DH1	יחח								EH		EH	ΕU					
10 μF 22 μF	226		K	M																UII.									EH ¹	LII	LIT					
22 μι	220	Dat.	ed Vol	_	<u>س</u>					_		-				•	•	_							_	_		i —					-	-	_	
	Cap		(VDC))	6.3	2	16	25	20	100	6.3	2	16	25	50	100	200	250	6.3	9	16	25	35	50	100	200	250	6.3	9	16	25	35	50	100	200	250
Cap	Code	Vol	tage C	ode	9	8	4	3	5	1	9	8	4	3	5	1	2	Α	9	8	4	3	6	5	1	2	A	9	8	4	3	6	5	1	2	Α
			ise Si Serie				C04	102C						C06	03C							C	080	5C							C	120	6C			

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91). **Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82).

xx¹ Available only in K and M tolerance.

xx² Available only in M tolerance.



Table 1B - Capacitance Range/Selection Waterfall (1210 - 1812 Case Sizes)

			ise Siz Series					C12	10C				C	1805	5C	C	1808	C		C	1812	C ²	
Сар	Cap Code	Va	oltage Co	de	9	8	4	3	5	1	2	A	5	1	2	5	1	2	3	5	1	2	A
		Rated	Voltage	(VDC)	6.3	9	16	25	20	100	200	250	50	100	200	50	100	200	25	50	100	200	250
		Ca	p Tolera	nce		Proc	luct A	vailab	oility a	and Cl	nip Th	ickne	ess Co	des -	See 1	Table :	2 for (Chip T	hickn	ess D	imens	ions	
10 - 20 pF*	100 - 200*	J	К	М	FB	FB	FB	FB	FB	FB	FB												
22 pF	220	J	K	M	FB	FB	FB	FB	FB	FB	FB												
24 - 91pF	240 - 910*	J	K	M	FB	FB	FB	FB	FB	FB	FB												
100 - 150 pF**	101 - 151**	J	K	M	FB	FB	FB	FB	FB	FB	FB												
220 pF	221	J	K	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC								
270 pF	271	J	K	М	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC								
330 pF	331	J	К	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF					
390 pF	391	J	к	М	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF					
470 pF	471	J	к	м	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF	GB	GB	GB	GB	
560 pF	561	J	к	м	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF	GB	GB	GB	GB	
680 pF	681	J	К	М	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF	GB	GB	GB	GB	
820 pF	821	Ĵ	к	м	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF	GB	GB	GB	GB	
1000pF	102	J	ĸ	M	FB	FB	FB	FB	FB	FB	FB		NC	NC	NC	LF	LF	LF	GB	GB	GB	GB	
1200 pF	122	J	ĸ	M	FB	FB	FB	FB	FB	FB	FB		NC	NC		LF	LF	LF	GB	GB	GB	GB	
1500 pF	152	J.	ĸ	M	FB	FB	FB	FB	FB	FB	FE		NC	NC		LF	LF	LF	GB	GB	GB	GB	
1800 pF	182	J	K	M	FB	FB	FB	FB	FB	FB	FE		NC	NC		LF	LF	LF	GB	GB	GB	GB	
2200 pF	222	J	ĸ	M	FB	FB	FB	FB	FB	FB	FB	FB	NC	NC		LF	LF	LF	GB	GB	GB	GB	
2700 pF	272	J	ĸ	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA	NA	LF	LF	LF	GB	GB	GB	GB	
3300 pF	332	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA	NA	LF	LF	-	GB	GB	GB	GB	
3900 pF	392	J	ĸ	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA	NA	LF	LF		GB	GB	GB	GB	
4700 pF	472	5	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA	NA	LD	LD	LD	GB	GB	GB	GD	
5600 pF	562	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA	NA		LD	LD	GB	GB	GB	GH	
6800 pF	682	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA	INA			LD	GB	GB	GB	GB	GB
	822	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA				LD	GB	GB	GB	GB	GB
8200 pF	-	J	K			FB	FB	FB	FB	FB	FB	FB									GB		GB
10000 pF	103			M	FB								NA	NA				LD	GB	GB	-	GB	-
12000 pF	123	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	LD	GB	GB	GB	GB	GB
15000 pF	153	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	LD	GB	GB	GB	GB	GB
18000 pF	183	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD	LD	GB	GB	GB	GB	GB
22000 pF	223	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD		GB	GB	GB	GB	GB
27000 pF	273	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA	NA		LD	LD		GB	GB	GB	GB	GB
33000 pF	333	J	K	M	FB	FB	FB	FB	FB	FB	FB	FB	NA			LD	LD		GB	GB	GB	GB	GB
39000 pF	393	J	K	М	FB	FB	FB	FB	FB	FB	FB	FB	NA			LD	LD		GB	GB	GB	GB	GB
47000 pF	473	J	K	M	FB	FB	FB	FB	FB	FB	FC	FC	NA			LD	LD		GB	GB	GB	GB	GB
56000 pF	563	J	K	M	FB	FB	FB	FB	FB	FB	FC	FC	NA			LD	LD		GB	GB	GB	GB	GB
68000 pF	683	J	K	M	FB	FB	FB	FB	FB	FB	FC	FC	NA			LD			GB	GB	GB	GB	GB
		Rated	Voltage	(VDC)	6.3	9	16	25	20	100	200	250	20	<u>1</u> 0	200	20	100	200	25	20	100	200	250
Cap	Cap Code	Va	oltage Co	de	9	8	4	3	5	1	2	A	5	1	2	5	1	2	3	5	1	2	A
	ovue	Case	Itage Code 9 Size/Series				C12	10C				C	1805	C	C	1808	C		C	18120	2 2	,	

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91). **Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82).

xx¹ Available only in K and M tolerance.

² Available capacitance values available in X7R with KONNEKT Technology.



Table 1B - Capacitance Range/Selection Waterfall (1210 - 1812 Case Sizes) cont.

			ise Si Series					C12	10C				C	1805	5C	C	1808	BC		C 1	1812	C ²	
Сар	Cap Code	Vo	oltage Co	de	9	8	4	3	5	1	2	A	5	1	2	5	1	2	3	5	1	2	A
		Rated	l Voltage	(VDC)	6.3	9	16	25	20	100	200	250	50	100	200	50	100	200	25	50	100	200	250
		Ca	p Tolera	nce		Proc	luct A	vailab	oility a	and Cl	nip Th	ickne	ss Co	des -	See	Table 2	2 for (Chip T	hickn	ess D	imens	ions	
82000 pF	823	J	K	М	FB	FB	FB	FB	FB	FC	FF	FF	NA			LD			GB	GB	GB	GB	GB
0.1 µF	104	J	K	M	FB	FB	FB	FB	FB	FD	FG	FG	NA			LD			GB	GB	GB	GB	GB
0.12 µF	124	J	K	M	FB	FB	FB	FB	FB	FD	FH	FH				LD			GB	GB	GB	GB	GB
0.15 µF	154	J	K	M	FC	FC	FC	FC	FC	FD	FM	FM				LD			GB	GB	GB	GE	GE
0.18 µF	184	J	K	М	FC	FC	FC	FC	FC	FD	FK	FK				LD			GB	GB	GB	GG	GG
0.22 µF	224	J	K	M	FC	FC	FC	FC	FC	FD	FK	FK							GB	GB	GB	GG	GG
0.27 µF	274	J	K	M	FC	FC	FC	FC	FC	FD	FP	FP							GB	GB	GG	GG	GG
0.33 µF	334	J	K	M	FD	FD	FD	FD	FD	FD	FM	FM							GB	GB	GG	GG	GG
0.39 µF	394	J	K	M	FD	FD	FD	FD	FD	FD	FK	FK							GB	GB	GG	GG	GG
0.47 µF	474	J	K	M	FD	FD	FD	FD	FD	FD	FS	FS							GB	GB	GG	GJ	GJ
0.56 µF	564	J	K	M	FD	FD	FD	FD	FD	FF									GC	GC	GG		
0.68 µF	684	J	K	M	FD	FD	FD	FD	FD	FG									GC	GC	GG		
0.82 µF	824	J	K	M	FF	FF	FF	FF	FF	FL									GE	GE	GG		
1 µF	105	J	K	M	FH	FH	FH	FH	FH	FM									GE	GE	GG		
1.2 µF	125	J	K	M	FH	FH	FH	FH	FG	FH									GB	GB	GB		
1.5 µF	155	J	K	M	FH	FH	FH	FH	FG	FM									GC	GC	GC		
1.8 µF	185	J	K	M	FH	FH	FH	FH	FG	FJ									GE	GE	GE		
2.2 µF	225	J	K	M	FJ	FJ	FJ	FJ	FG	FY1									GO	GO	G01		
2.7 µF	275	J	K	M	FE	FE	FE	FG	FH										GJ	GJ	GJ		
3.3 µF	335	J	K	M	FF	FF	FF	FM	FM										GL	GL	GL		
3.9 µF	395	J	K	M	FG	FG	FG	FG	FK										GK	GK			
4.7 µF	475	J	ĸ	м	FC	FC	FC	FG	FS										GK	GK			
5.6 µF	565	J	К	М	FF	FF	FF	FH															
6.8 μF	685	J	К	М	FG	FG	FG	FM															
8.2 μF	825	J	К	М	FH	FH	FH	FK															
10 µF	106	J	K	М	FT1	FT1	FT1	GA ¹	FS ¹										GK				
15 μF	156	J	K	М	FM	FM																	
22 µF	226				FS	FS	FS1	FS ¹															
47 µF	476				FS1	FS1																	
	0	Rated	l Voltage	(VDC)	6.3	10	16	25	50	100	200	250	50	100	200	50	100	200	25	50	100	200	250
Cap	Cap Code	Vo	oltage Co	de	9	8	4	3	5	1	2	A	5	1	2	5	1	2	3	5	1	2	A
	oue	Case	Voltage Code 9 se Size/Series			~		C12	10C			<u>.</u>	c	1805	C	C	1808	С		C	18120	2	

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91). **Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82).

xx¹ Available only in K and M tolerance.

Downloaded from Arrow.com.

² Available capacitance values available in <u>X7R with KONNEKT Technology</u>.

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Table 1C - Capacitance Range/Selection Waterfall (1825 - 2225 Case Sizes)

		Case	e Size/S	eries		C18	25C			С	2220	С			C22	25C	
Сар	Cap Code	<u>۱</u>	/oltage Cod	le	5	1	2	A	3	5	1	2	Α	5	1	2	A
		Rate	d Voltage (VDC)	50	100	200	250	25	50	100	200	250	50	00	200	250
			ap Toleran											Chip Thi			
3900 pF	392	J	K	М	HB	HB	HB									_	
4700 pF	472	J	K	М	HB	HB	HB							KE	KE	KE	
5600 pF	562	J	K	М	HB	HB	HB							KE	KE	KE	
6800 pF	682	J	K	M	HB	HB	HB		JE	JE	JE			KE	KE	KE	
8200 pF	822	J	K	М	HB	HB	HB		JE	JE	JE			KE	KE	KE	
10000 pF	103	J	K	М	НВ	HB	HE		JE	JE	JE			KE	KE	KE	
12000 pF	123	J	K	м	НВ	НВ	HE		JE	JE	JE			KE	KE	KE	
15000 pF	153	J	К	м	НВ	НВ			JE	JE	JE			KE	KE	KE	
18000 pF	183	J	к	м	НВ	HE			JE	JE	JE			KE	KE		
22000 pF	223	Ĵ	K	M	НВ	НВ	НВ	НВ	JE	JE	JE			KE	KE		
27000 pF	273	J	K	M	HB	HB	HB	HB	JE	JE	JE			KE	KE		
33000 pF	333	J	K	M	HB	HB	HB	HB	JB	JB	JB			KE			
39000 pF	393	Ĵ	K	M	НВ	НВ	HB	НВ	JB	JB	JB						
47000 pF	473	J	K	M	НВ	НВ	НВ	НВ	JB	JB	JB						
56000 pF	563	J	K	M	НВ	HB	HB	HB	JB	JB	JB						
68000 pF	683	J	K	M	HB	HB	HB	HB	JB	JB	JB						
82000 pF	823	J	K	M	НВ	HB	HB	HB	JC	JC	JC	JC	JC				
0.1 µF	104	J	K	M	HB	HB	HB	HB	JC	JC	JC	JC	JC	кс	кс	кс	кс
0.12 µF	124	J	K	M	HB	HB	HB	HB	JC	JC	JC	JC	JC	KC	KC	KC	KC
0.12 µF	154	J	K	M	HB	HB	HB	HB	JC	JC	JC	JC	JC	KC	KC	KC	KC
0.15 µF	184	J	K	M	HB	HB	НВ	HB	JC	JC	JC	JC	JC	KC	KC	KC	KC
0.18 μF	224	J	K	M	НВ	НВ	НВ	НВ	JC	JC	JC	JC	JC	KC	KC	KC	KC
	274	J			НВ	НВ		НВ		JC		JC		KC	KC	KC	
0.27 µF	334	-	K	M	НВ	НВ	HB HB	НВ	JC JC	JC	JC JC	JC	JC JC	KB	KC	KC	KC KC
0.33 µF		J	K														
0.39 µF	394	J	K	M	HB	HB	HD	HD	JC	JC	JC	JC	JC	KB	KC	KC	KC
0.47 µF	474	J	K	M	HB	HB	HD	HD	JC	JC	JC	JC	JC	KB	KC	KD	KD
0.56 µF	564	J	K	M	HB	HD	HD	HD	JC	JC	JC	JD	JD	KB	KC	KD	KD
0.68 µF	684	J	K	M	HB	HD	HD	HD	JC	JC	JD	JD	JD	KB	KC	KD	KD
0.82 µF	824	J	K	M	HB	HF	HF	HF	JC	JC	JF	JF	JF	KB	KC	KE	KE
1.0 µF	105	J	K	M	HB	HF	HF	HF	JC	JC	JF	JF	JF	KB	KD	KE	KE
1.2 µF	125	J	K	M	HB				JC	JC				KB	KE	KE	KE
1.5 μF	155	J	K	M	HC				JC	JC				KC			
1.8 μF	185	J	K	М	HD				JD	JD				KD			
2.2 µF	225	J	K	М	HF				JF	JF				KD			
4.7 μF	475	J	K	М					JF	JF							
10 µF	106	J	K	М					JF	JO							
15 µF	156	J	K	M					JO	JO							
22 µF	226	J	K	М					JO								
		Rate	d Voltage (VDC)	50	100	200	250	25	50	100	200	250	50	100	200	250
Сар	Cap Code	<u> </u>	/oltage Cod	le	5	1	2	A	3	5	1	2	A	5	1	2	A
		Cas	Case Size/Series			C18	25C			(C22200	;			C22	25C	

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82, and 91). **Capacitance range Includes E12 decade values only. (i.e., 10, 12, 15, 18, 22, 27, 33, 39, 47, 56, 68, and 82).

xx¹ Available only in K and M tolerance.

² Available capacitance values available in <u>X7R with KONNEKT Technology</u>.



Table 2A – Chip Thickness/Tape & Reel Packaging Quantities

Thickness	Case	Thickness ±	Paper Q	uantity ¹	Plastic	Quantity		
Code	Size ¹	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel		
BB	0402	0.50 ± 0.05	10,000	50,000	0	0		
CF	0603	0.80 ± 0.07	4,000	15,000	0	0		
CG	0603	0.80 ± 0.10	4,000	15,000	0	0		
CJ	0603	0.80 ± 0.15	4,000	15,000	0	0		
DM	0805	0.70 ± 0.20	4,000	15,000	0	0		
DN	0805	0.78 ± 0.10	4,000	15,000	0	0		
DO	0805	0.80 ± 0.10	4,000	15,000	0	0		
DP	0805	0.90 ± 0.10	4,000	15,000	0	0		
DE	0805	1.00 ± 0.10	0	0	2,500	10,000		
DG	0805	1.25 ± 0.15	0	0	2,500	10,000		
DH	0805	1.25 ± 0.20	0	0	2,500	10,000		
EB	1206 1206	0.78 ± 0.10	0	0	4,000	10,000		
EQ EC	1206	0.78 ±0.20 0.90 ± 0.10	0 0	0 0	4,000 4,000	10,000 10,000		
EN	1206	0.90 ± 0.10 0.95 ± 0.10	0	0	4,000	10,000		
EN	1200	1.00 ± 0.10	0	0	2,500	10,000		
EE	1206	1.10 ± 0.10	0	0	2,500	10,000		
EF	1200	1.20 ± 0.15	0	0	2,500	10,000		
EP	1206	1.20 ± 0.10	0	0	2,500	10,000		
EM	1206	1.25 ± 0.25	0 0	Ő	2,500	10,000		
EG	1206	1.60 ± 0.15	0	0	2,000	8,000		
EH	1206	1.60 ± 0.20	Ő	Ő	2,000	8,000		
FB	1210	0.78 ± 0.10	0	0	4,000	10,000		
FC	1210	0.90 ± 0.10	0	0	4,000	10,000		
FD	1210	0.95 ± 0.10	0	0	4,000	10,000		
FE	1210	1.00 ± 0.10	0	0	2,500	10,000		
FF	1210	1.10 ± 0.10	0	0	2,500	10,000		
FG	1210	1.25 ± 0.15	0	0	2,500	10,000		
FL	1210	1.40 ± 0.15	0	0	2,000	8,000		
FH	1210	1.55 ± 0.15	0	0	2,000	8,000		
FP	1210	1.60 ± 0.20	0	0	2,000	8,000		
FM	1210	1.70 ± 0.20	0	0	2,000	8,000		
FJ	1210	1.85 ± 0.20	0	0	2,000	8,000		
FT	1210	1.90 ± 0.20	0	0	2,000	8,000		
GA	1210	1.90 ± 0.20*	0	0	1,000	4,000		
FY	1210	2.00 ± 0.20	0	0	2,000	8,000		
FK FS	1210	2.10 ± 0.20	0	0	2,000	8,000		
FS NA	1210 1805	2.50 ± 0.30 0.90 ± 0.10	0 0	0 0	1,000 4,000	4,000 10,000		
NA	1805	0.90 ± 0.10 1.00 ± 0.15	0	0	4,000 4,000	10,000		
LD	1803	0.90 ± 0.10	0	0	2,500	10,000		
LF	1808	1.00 ± 0.15	0	0	2,500	10,000		
GB	1812	1.00 ± 0.10	0	0	1,000	4,000		
GC	1812	1.10 ± 0.10	Ő	0 0	1,000	4,000		
GD	1812	1.25 ± 0.15	Ő	Ő	1,000	4,000		
GE	1812	1.30 ± 0.10	0	0	1,000	4,000		
GH	1812	1.40 ± 0.15	0	0	1,000	4,000		
GG	1812	1.55 ± 0.10	0	0	1,000	4,000		
GK	1812	1.60 ± 0.20	0	0	1,000	4,000		
GJ	1812	1.70 ± 0.15	0	0	1,000	4,000		
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel		
Code	Size ¹	Range (mm)	Paper Q	uantity ¹	Plastic	Quantity		
		finiahad ahin thiak			Plastic Quantity			

Package quantity based on finished chip thickness specifications.

¹ If ordering using the 2 mm Tape and Reel pitch option, the packaging quantity outlined in the table above will be doubled. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information."

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Thickness	Case	Thickness ±	Paper Q	uantity ¹	Plastic (Quantity
Code	Size ¹	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel
GL	1812	1.90 ± 0.20	0	0	500	2,000
GO	1812	2.50 ± 0.20	0	0	500	2,000
HB	1825	1.10 ± 0.15	0	0	1,000	4,000
HC	1825	1.15 ± 0.15	0	0	1,000	4,000
HD	1825	1.30 ± 0.15	0	0	1,000	4,000
HE	1825	1.40 ± 0.15	0	0	1,000	4,000
HF	1825	1.50 ± 0.15	0	0	1,000	4,000
JB	2220	1.00 ± 0.15	0	0	1,000	4,000
JC	2220	1.10 ± 0.15	0	0	1,000	4,000
JD	2220	1.30 ± 0.15	0	0	1,000	4,000
JE	2220	1.40 ± 0.15	0	0	1,000	4,000
JF	2220	1.50 ± 0.15	0	0	1,000	4,000
JO	2220	2.40 ± 0.15	0	0	500	2,000
KB	2225	1.00 ± 0.15	0	0	1,000	4,000
KC	2225	1.10 ± 0.15	0	0	1,000	4,000
KD	2225	1.30 ± 0.15	0	0	1,000	4,000
KE	2225	1.40 ± 0.15	0	0	1,000	4,000
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel
Code	Size ¹	Range (mm)	Paper Q	uantity ¹	Plastic	Quantity

Table 2A - Chip Thickness/Tape & Reel Packaging Quantities cont.

Package quantity based on finished chip thickness specifications.

¹ If ordering using the 2 mm Tape and Reel pitch option, the packaging quantity outlined in the table above will be doubled. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information."

Table 2B – Bulk Packaging Quantities

Deeker	ing Tune	Loose P	ackaging
Раскау	ing Type	Bulk Bag	(default)
Packagin	g C-Spec¹	N,	/A²
Case	Size	Packaging Quantities (pieces/unit packaging)
EIA (in)	Metric (mm)	Minimum	Maximum
0402	1005		
0603	1608		
0805	2012		50,000
1206	3216		
1210	3225	1	
1808	4520		
1812	4532		
1825	4564		20,000
2220	5650		
2225	5664		

¹ The "Packaging C-Spec" is a 4 to 8 digit code which identifies the packaging type and/or product grade. When ordering, the proper code must be included in the 15th through 22nd character positions of the ordering code. See "Ordering Information" section of this document for further details. Commercial grade product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging. Contact KEMET if you require a bulk bag packaging option for automotive grade products.

² A packaging C-Spec (see note 1 above) is not required for "Bulk Bag" packaging (excluding anti-static Bulk Bag and automotive grade products). The 15th through 22nd character positions of the ordering code should be left blank. All product ordered without a packaging C-Spec will default to our standard "Bulk Bag" packaging.

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Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC-7351

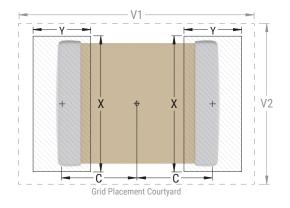
EIA Size Code	Metric Size Code			sity Lev mum (I rotrusio	Most))		Media	sity Lev an (Nor rotrusio)			sity Lev mum (L rotrusio	.east))
		C	Y	X	V1	V2	C	Y	X	V1	V2	C	Y	X	V1	V2
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90
1210 ¹	3225	1.50	1.60	2.90	5.60	3.90	1.40	1.40	2.80	4.70	3.30	1.30	1.20	2.70	4.00	3.00
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70
1825	4564	2.15	1.60	6.90	6.90	7.90	2.05	1.40	6.80	6.00	7.30	1.95	1.20	6.70	5.30	7.00
2220	5650	2.75	1.70	5.50	8.20	6.50	2.65	1.50	5.40	7.30	5.90	2.55	1.30	5.30	6.60	5.60
2225	5664	2.70	1.70	6.90	8.10	7.90	2.60	1.50	6.80	7.20	7.30	2.50	1.30	6.70	6.50	7.00

¹ Only for capacitance values $\ge 22 \ \mu F$

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805, and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for an EIA 1210 case size.





Soldering Process

Recommended Soldering Technique:

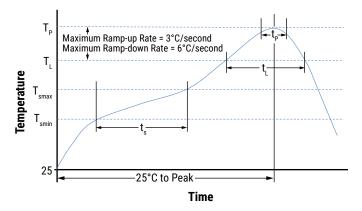
- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile:

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/ J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Terminati	ion Finish
i ionici cuture	SnPb	100% Matte Sn
Preheat/Soak		
Temperature Minimum (T _{Smin})	100°C	150°C
Temperature Maximum (T _{Smax})	150°C	200°C
Time (t_s) from T_{smin} to T_{smax}	60 – 120 seconds	60 – 120 seconds
Ramp-Up Rate $(T_L to T_p)$	3°C/second maximum	3°C/second maximum
Liquidous Temperature (T_L)	183°C	217°C
Time Above Liquidous (t_L)	60 – 150 seconds	60 – 150 seconds
Peak Temperature (T _P)	235°C	260°C
Time Within 5°C of Maximum Peak Temperature (t _p)	20 seconds maximum	30 seconds maximum
Ramp-Down Rate $(T_p to T_L)$	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.



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Test	Reference	Test Condition		l	.imits			
Visual and Mechanical	KEMET Internal	No defects that may affect performance (10X)	Dime	ensions accor	ding KEMET S	pec Sheet		
Capacitance (Cap)	KEMET Internal	C ≤ 10 μF 1 kHz ±50 Hz and 1.0 ±0.2 V _{rms} or 0.5 ±0.2 V _{rms} * C > 10 μF 120 Hz ±10 Hz and 0.5 ±0.1 V _{rms} * See part number specification sheet for voltage Capacitance measurements (including tolerance) are indexed to a referee time of 48 or 1,000 hours Please refer to a part number specification sheet for referee time details	ce) within folerance					
				Within	Specification			
			EIA Case Size	Rated DC Voltage	Capacitance	Dissipation Factor (Maximum %)		
				< 16	< 0.1 µF ≥ 0.1 µF	5.0		
			0402	16	< 0.1 µF ≥ 0.1 µF	3.5		
				25	< 0.1 µF ≥ 0.1 µF	3.5		
				> 25	All	2.5		
				< 16		5.0		
			06031	16 / 25	< 1.0 µF	3.5		
				> 25	-	2.5		
				< 16 16 / 25	≥ 1.0 µF	10.0		
		C ≤ 10 μF Frequency: 1 kHz ±50 Hz	08052	< 16		5.0		
				16 / 25	< 2.2 µF	3.5		
		Voltage*: 1.0 ±0.2 V _{rms} ,0.5 ±0.2 V _{rms}		> 25	< 1.0 µF	2.5		
Dissipation	KEMET			< 16				
Factor (DF)	Internal	C > 10 μF Frequency: 120 Hz ±10 Hz Voltage: 0.5 ±0.1 V _{rms}		16 / 25	≥ 2.2 µF	10.0		
				> 25	≥ 1.0 µF	-		
				< 16		5.0		
		* See part number specification sheet for voltage		16 / 25	< 10 µF	3.5		
			1206³	> 25	All	2.5		
				< 16				
				16 / 25	≥ 10 µF	10.0		
				< 16		5.0		
				16 / 25	< 22 µF	3.5		
			1210 ⁴	> 25		2.5		
				< 16				
				16 / 25	≥ 22 µF	10.0		
				< 16		5.0		
			1805 - 2225	16 / 25	All	3.5		
				> 25		2.5		
			² For Cap value 1.0 µ ¹ ³ For Cap value 2.2 µ ¹ (100V) DF is 5%	E (16 V and 25 V) DF E (25 V) and ≥ 2.2 μF (16 V, 25 V and 50 V)	is 5%. (35 V and 50 V) DF is	lue 4.7 μF (25 V) DF is 3.5% s 10%, for Cap Value 1.0 μF lue 4.7μF (50 V) DF is 5%, fc		

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Test	Reference	Test Condition		Limits																																				
			То	obtain IR limi	Within Spe t, divide MΩ - μF value by t Select the lower o	he capacitance and comp	pare to GΩ limit.																																	
					Insulation Resistanc	e (IR) Limits Table																																		
			EIA Case Size	Rated DC Voltage	1,000 megohm microfarads or 100 GΩ	500 megohm microfarads or 10 GΩ	100 megohm microfarads or 10 GΩ																																	
			0402	ALL	< 0.012 µF	≥ 0.012 µF < 0.47 µf	≥ 0.47 µf																																	
			06001	≤ 200 V	< 0.047 µF	≥ 0.047 µf < 0.47 µf	≥ 0.47 µf																																	
			06031	250 V	N/A	N/A	ALL																																	
		5					0805 ²	≤ 200 V	< 0.15 µF	≥ 0.15 µF < 2.2 µf	≥ 2.2 µf																													
			0803	250 V	< .027 µF	N/A	≥ .027 µF																																	
Insulation	KENTET		voltage for 120 seconds	voltage for 120 seconds	1206 ³	≤ 200 V	< 0.47 µF	≥ 0.47 µF < 2.2 µf	≥ 2.2 µf																															
Resistance	KEMET Internal				120 seconds	120 seconds			1200	250 V	< 0.12 µF	N/A	≥ 0.12 µF																											
(IR)							12104	≤ 200 V	< 0.39 µF	≥ 0.39 µF < 10 µf	≥ 10 µf																													
							1210	250 V	< 0.27 µF	N/A	≥ 0.27 µF																													
									1805	ALL	ALL	N/A	N/A																											
						1808	ALL	ALL	N/A	N/A																														
																																								1812
			1825	ALL	ALL	N/A	N/A																																	
			2220	ALL	< 10 µF	≥ 10 µF	N/A																																	
			2225	ALL	ALL	N/A	N/A																																	
						For Cap value ² For Cap value For Cap value ³ For Cap value	s 5.6nF, 6.8nF, 8 1.0μF (50 V) IR 0.1uF (≤ 50V) I 4.7μF (50 V) IR	IR should be calculated under 50 8.2nF & 10nF (100V) IR should be should be calculated under 100 R should be calculated under 500 should be calculated under 100 R should be calculated under 100	e calculated under 500 megohn megohm microfarads or 10 GΩ 0 mohms or 10G0hms megohm microfarads or 10 GΩ	n microfarads or 10 GΩ.																														



Test	Reference	Test Condition	Limits
Temperature Coefficient of Capacitance (TCC)	KEMET Internal	Capacitance ±15% over -55°C to +125°C	
		3 +25°C (Reference) 4 +125°C	
Dielectric Withstanding Voltage (DWV)	KEMET Internal	250% of rated voltage (5 ±1 seconds and charge/discharge not exceeding 50 mA)	Cap: Initial Limit DF: Initial Limit IR: Initial Limit Withstand test voltage without
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	KEMET Internal	Capacitance measurements (including tolerance) are indexed to a referee time of 48 or 1,000 hours. Please refer to a part number specific datasheet for referee time details.	insulation breakdown or damage. Please refer to a part number specification sheet for specific Aging rate
Terminal Strength	KEMET Internal	Shear stress test per specific case size, Time: 60±1 secondsCase SizeForce02012N04023N06035N08059N≥120618N	No evidence of mechanical damage
Board Flex	AEC-Q200-005	Standard Termination system 2.0 mm Flexible Termination System 3.0 mm Test time: 60± 5 seconds Ramp time: 1 mm/second	No evidence of mechanical damage



Test	Reference	Test Condition	Limits				
Solderability	J-STD-002	Condition: 4 hours ± 15 minutes at 155°C dry bake apply all methods Test 245 ±5°C (SnPb and Pb-Free)	Visual Inspection. 95% coverage on termination. No leaching				
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C) 2 – 3 cycles per hour Soak Time 1 or 5 minutes	Measurement at 24 hours ±4 hours after test conclusion. Cap: Initial Limit DF: Initial Limit IR: Initial Limit				
		Load Humidity:	Measurement at 24 hours ±4 hours after test conclusion. Within Post Environmental Limits Cap: ±20% shift IR: 10% of Initial Limit				
Biased	MIL-STD-202	1,000 hours 85°C/85% RH and rated voltage.	DF Limits Maximum (%)				
Humidity	Method 103	Low Volt Humidity: 1,000 hours 85C°/85% RH and 1.5 V.	Initial Post				
		1,000 11001S 63C 765% KH aliu 1.5 V.	2.5 3.0				
		3.5 5.0					
			5.0 7.5 10.0 20.0				
			Measurement at 24 hours ±4 hours after test conclusion. Within Post Environmental Limits Cap: ±20% shift IR: 10% of Initial Limit				
Moisture	MIL-STD-202	Number of cycles required 10, 24 hours per cycle.	DF Limits Maximum (%)				
Resistance	Method 106	Steps 7a and 7b not required.	Initial Post				
			2.5 3.0				
			3.5 5.0				
			5.0 7.5				
			10.0 20.0				
Thermal Shock	MIL-STD-202 Method 107	Number of cycles required 5, (-55°C to 125°C) Dwell time 15 minutes.	Cap: Initial Limit DF: Initial Limit IR: Initial Limit				



Test	Reference		Test Condition		Lin	nits		
			125°C with 2 X rated xcluding the followi		With	nin Post Envir Cap: ±2 IR: 10% of I		nits
High Temperature	MIL-STD-202	Case Size	Capacitance	Applied Voltage		DF Li Maxim		
Life	Life MiL-STD-202 Method 108 $0603 \& 0805 \ge 1.0 \ \mu\text{F}$ 1.5 X $1206 \& 1210 \ge 10 \ \mu\text{F}$		Initial	Post				
			2.5	3.0				
						3.5	5.0	
						5.0	7.5	
	-					10.0	20.0	
Storage Life		1,000	hours at 125°C, Unp	owered				
Vibration	MIL-STD-202 Method 204		ites, 12 cycles each est from 10 – 2,000			Cap: Init DF: Initi IR: Initi	al Limit	
Mechanical Shock	MIL-STD-202 Method 213		1,500 g's 0.5 ms Half-sine, Velocity Change 15.4 feet/second (Condition F)				ial Limit al Limit al Limit	
Resistance to Solvents	MIL-STD-202 Method 215	(A 6% concent	Add Aqueous wash chemical OKEMCLEAN (A 6% concentrated Oakite cleaner) or equivalent. Do not use banned solvents.				ection 10X marking, ion or stains. Il damage.	

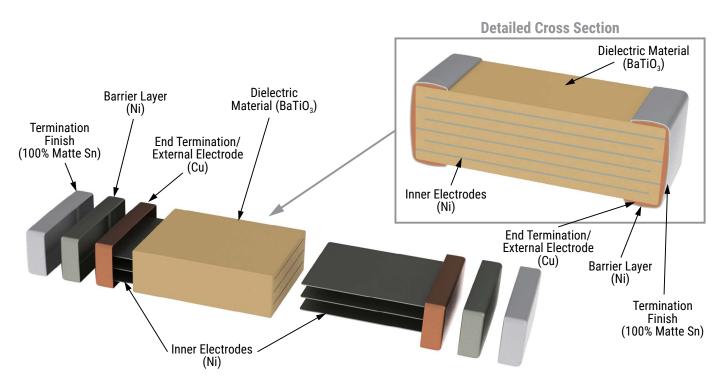
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Storage & Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.

Construction (Typical)





Capacitor Marking (Optional)

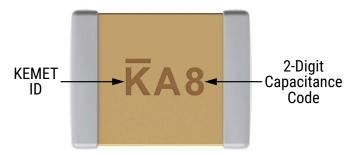
These surface mount multilayer ceramic capacitors are normally supplied unmarked. If required, they can be marked as an extra cost option. Marking is available on most KEMET devices, but must be requested using the correct ordering code identifier(s). If this option is requested, two sides of the ceramic body will be laser marked with a "K" to identify KEMET, followed by two characters (per EIA–198 - see table below) to identify the capacitance value. EIA 0603 case size devices are limited to the "K" character only.

Laser marking option is not available on:

- COG, ultra stable X8R and Y5V dielectric devices.
- EIA 0402 case size devices.
- EIA 0603 case size devices with flexible termination option.
- KPS commercial and automotive grade stacked devices.
- X7R dielectric products in capacitance values outlined below.

EIA Case Size	Metric Size Code	Capacitance
0603	1608	≤ 170 pF
0805	2012	≤ 150 pF
1206	3216	≤ 910 pF
1210	3225	≤ 2,000 pF
1808	4520	≤ 3,900 pF
1812	4532	≤ 6,700 pF
1825	4564	≤ 0.018 µF
2220	5650	≤ 0.027 µF
2225	5664	≤ 0.033 µF

Marking appears in legible contrast. Illustrated below is an example of an MLCC with laser marking of "KA8", which designates a KEMET device with rated capacitance of 100 μ F. Orientation of marking is vendor optional.





Capacitor Marking (Optional) cont.

	Capacitance (pF) For Various Alpha/Numeral Identifiers												
Alpha						Numera	al						
Alpha Character	9	0	1	2	3	4	5	6	7	8			
Character	Capacitance (pF)												
А	0.10	1.0	10	100	1,000	10,000	100,000	1,000,000	10,000,000	100,000,000			
В	0.11	1.1	11	110	1,100	11,000	110,000	1,100,000	11,000,000	110,000,000			
С	0.12	1.2	12	120	1,200	12,000	120,000	1,200,000	12,000,000	120,000,000			
D	0.13	1.3	13	130	1,300	13,000	130,000	1,300,000	13,000,000	130,000,000			
E	0.15	1.5	15	150	1,500	15,000	150,000	1,500,000	15,000,000	150,000,000			
F	0.16	1.6	16	160	1,600	16,000	160,000	1,600,000	16,000,000	160,000,000			
G	0.18	1.8	18	180	1,800	18,000	180,000	1,800,000	18,000,000	180,000,000			
Н	0.20	2.0	20	200	2,000	20,000	200,000	2,000,000	20,000,000	200,000,000			
J	0.22	2.2	22	220	2,200	22,000	220,000	2,200,000	22,000,000	220,000,000			
К	0.24	2.4	24	240	2,400	24,000	240,000	2,400,000	24,000,000	240,000,000			
L	0.27	2.7	27	270	2,700	27,000	270,000	2,700,000	27,000,000	270,000,000			
М	0.30	3.0	30	300	3,000	30,000	300,000	3,000,000	30,000,000	300,000,000			
N	0.33	3.3	33	330	3,300	33,000	330,000	3,300,000	33,000,000	330,000,000			
Р	0.36	3.6	36	360	3,600	36,000	360,000	3,600,000	36,000,000	360,000,000			
Q	0.39	3.9	39	390	3,900	39,000	390,000	3,900,000	39,000,000	390,000,000			
R	0.43	4.3	43	430	4,300	43,000	430,000	4,300,000	43,000,000	430,000,000			
S	0.47	4.7	47	470	4,700	47,000	470,000	4,700,000	47,000,000	470,000,000			
Т	0.51	5.1	51	510	5,100	51,000	510,000	5,100,000	51,000,000	510,000,000			
U	0.56	5.6	56	560	5,600	56,000	560,000	5,600,000	56,000,000	560,000,000			
V	0.62	6.2	62	620	6,200	62,000	620,000	6,200,000	62,000,000	620,000,000			
W	0.68	6.8	68	680	6,800	68,000	680,000	6,800,000	68,000,000	680,000,000			
Х	0.75	7.5	75	750	7,500	75,000	750,000	7,500,000	75,000,000	750,000,000			
Y	0.82	8.2	82	820	8,200	82,000	820,000	8,200,000	82,000,000	820,000,000			
Z	0.91	9.1	91	910	9,100	91,000	910,000	9,100,000	91,000,000	910,000,000			
а	0.25	2.5	25	250	2,500	25,000	250,000	2,500,000	25,000,000	250,000,000			
b	0.35	3.5	35	350	3,500	35,000	350,000	3,500,000	35,000,000	350,000,000			
d	0.40	4.0	40	400	4,000	40,000	400,000	4,000,000	40,000,000	400,000,000			
е	0.45	4.5	45	450	4,500	45,000	450,000	4,500,000	45,000,000	450,000,000			
f	0.50	5.0	50	500	5,000	50,000	500,000	5,000,000	50,000,000	500,000,000			
m	0.60	6.0	60	600	6,000	60,000	600,000	6,000,000	60,000,000	600,000,000			
n	0.70	7.0	70	700	7,000	70,000	700,000	7,000,000	70,000,000	700,000,000			
t	0.80	8.0	80	800	8,000	80,000	800,000	8,000,000	80,000,000	800,000,000			
у	0.90	9.0	90	900	9,000	90,000	900,000	9,000,000	90,000,000	900,000,000			



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

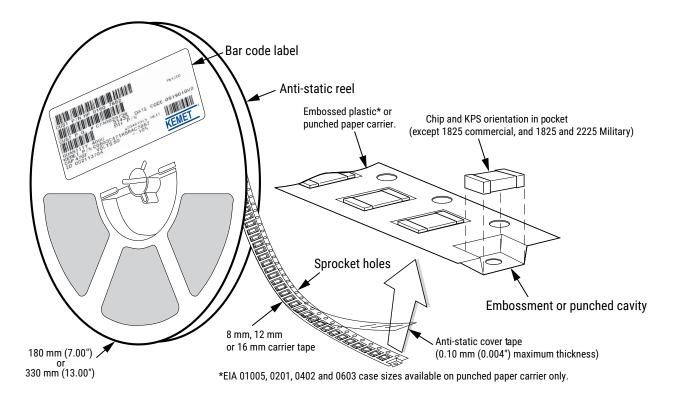


Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

	Таре	Embosse	ed Plastic	Punche	d Paper
EIA Case Size	Size	7" Reel	13" Reel	7" Reel	13" Reel
	(W)*	Pitch	(P ₁)*	Pitch	(P ₁)*
01005 - 0402	8			2	2
0603	8			2/4	2/4 -
0805	8	4	4	4	4
1206 - 1210	8	4	4	4	4
1805 - 1808	12	4	4		
≥ 1812	12	8	8		
KPS 1210	12	8	8		
KPS 1812 and 2220	16	12	12		
Array 0612	8	4	4		

*Refer to Figures 1 and 2 for W and P₁ carrier tape reference locations. *Refer to Tables 6 and 7 for tolerance specifications.

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New 2 mm Pitch Reel Options*

Packaging Ordering Code (C-Spec)	Packaging Type/Options
C-3190	Automotive grade 7" reel unmarked
C-3191	Automotive grade 13" reel unmarked
C-7081	Commercial grade 7" reel unmarked
C-7082	Commercial grade 13" reel unmarked

* 2 mm pitch reel only available for 0603 EIA case size. 2 mm pitch reel for 0805 EIA case size under development.

Benefits of Changing from 4 mm to 2 mm Pitching Spacing

- Lower placement costs.
- Double the parts on each reel results in fewer reel changes and increased efficiency.
- Fewer reels result in lower packaging, shipping and storage costs, reducing waste.



Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

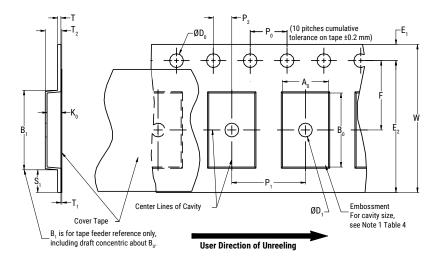


Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions – Millimeters (Inches)												
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T ₁ Maximum				
8 mm		1.0 (0.039)				25.0 (0.984)							
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)				
16 mm		(0.059)				(1.181)							
		,	Variable Dime	ensions — Mil	limeters (Inch	nes)							
Tape Size	Pitch	B ₁ Maximum Note 4	E ₂ Minimum	F	P ₁	T ₂ Maximum	W Maximum	A ₀ ,B ₀	& K ₀				
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)						
12 mm	Single (4 mm) and double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Note 5					
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)						

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of the embossment location and the hole location shall be applied independently of each other.

2. The tape with or without components shall pass around R without damage (see Figure 6.)

3. If S₁ < 1.0 mm, there may not be enough area for a cover tape to be properly applied (see EIA Standard 481, paragraph 4.3, section b.)

4. B, dimension is a reference dimension for tape feeder clearance only.

5. The cavity defined by A_{μ} , B_{μ} and K_{μ} shall surround the component with sufficient clearance that:

(a) the component does not protrude above the top surface of the carrier tape.

(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

(c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3.)

(d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4.)

(e) for KPS product, A_{a} and B_{a} are measured on a plane 0.3 mm above the bottom of the pocket.

(f) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.

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Figure 2 – Punched (Paper) Carrier Tape Dimensions

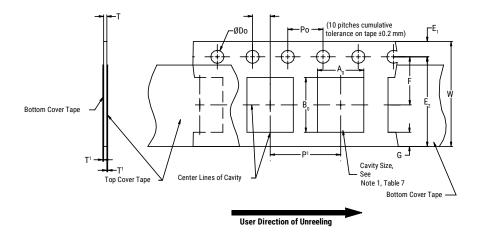


Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)												
Tape Size	D _o	E ₁	P ₀	P ₂	T ₁ Maximum	G Minimum	R Reference Note 2						
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) maximum	0.75 (0.030)	25 (0.984)						
		Variable D	imensions — M	illimeters (Inche	es)								
Tape Size	Pitch	E2 Minimum	F	P ₁	T Maximum	W Maximum	A ₀ B ₀						
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1						
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	NOLE I						

1. The cavity defined by A_{α} , B_{α} and T shall surround the component with sufficient clearance that:

a) the component does not protrude beyond either surface of the carrier tape.

b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

c) rotation of the component is limited to 20° maximum (see Figure 3.)

d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4.)

e) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.

2. The tape with or without components shall pass around R without damage (see Figure 6.)



Packaging Information Performance Notes

- 1. Cover Tape Break Force: 1.0 kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength	
8 mm	0.1 to 1.0 newton (10 to 100 gf)	
12 and 16 mm	0.1 to 1.3 newton (10 to 130 gf)	

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of $300 \pm 10 \text{ mm/minute}$.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

Figure 3 – Maximum Component Rotation

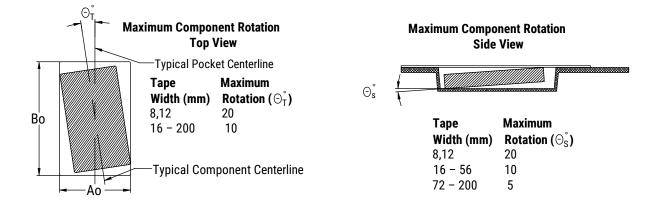


Figure 4 – Maximum Lateral Movement

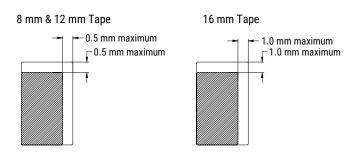


Figure 5 – Bending Radius

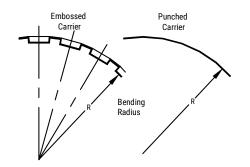
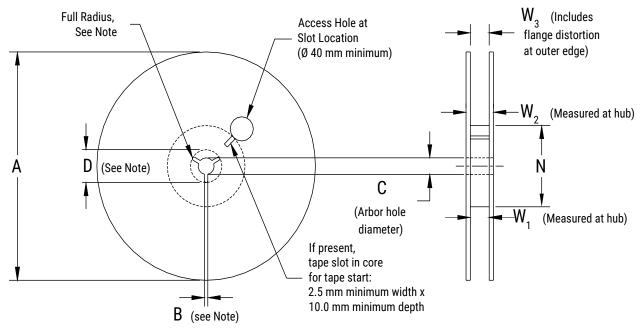




Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 – Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)					
Tape Size	А	B Minimum	C	D Minimum	
8 mm	178 ±0.20 (7.008 ±0.008) or 330 ±0.20 (13.000 ±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)	
12 mm					
16 mm					
Variable Dimensions – Millimeters (Inches)					
Tape Size	N Minimum	W ₁	W ₂ Maximum	W ₃	
8 mm	50 (1.969)	8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)	Shall accommodate tape width without interference	
12 mm		12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)		
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)		



Figure 7 – Tape Leader & Trailer Dimensions

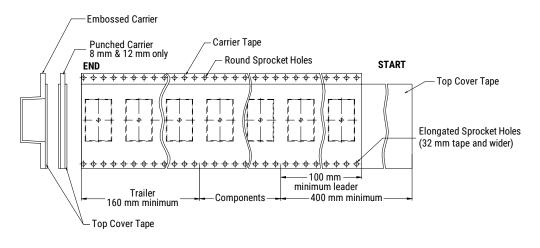


Figure 8 – Maximum Camber





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